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SN74AXC8T245

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SN74AXC8T245 8-Bit Dual-Supply Bus Transceiver With Configurable Voltage Translation and Tri-State Outputs

1 Features

- Qualified Fully Configurable Dual-Rail Design Allows Each Port to Operate With a Power Supply Range From 0.65 V to 3.6 V
- Operating Temperature From -40°C to +125°C
- Multiple Direction Control Pins to Allow Simultaneous Up and Down Translation
- Up to 380 Mbps Support When Translating from 1.8 V to 3.3 V
- V_{CC} Isolation Feature to Effectively Isolate Both Buses in a Power-Down Scenario
- Partial Power-Down Mode to Limit Backflow Current in a Power-Down Scenario
- Compatible With SN74AVC8T245 and 74AVC8T245 Level Shifters
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 8000-V Human-Body Model
 - 1000-V Charged-Device Model

2 Applications

- Enterprise and Communications
- Industrial
- **Personal Electronics**
- Wireless Infrastructure
- **Building Automation**
- Point of Sale

3 Description

The SN74AXC8T245 device is an 8-bit non-inverting bus transceiver that resolves voltage level mismatch between devices operating at the latest voltage nodes (0.7 V, 0.8 V, and 0.9 V) and devices operating at industry standard voltage nodes (1.8 V, 2.5 V, 3.3 V) and vice versa.

The device operates by using two independent power-supply rails (V_{CCA} and V_{CCB}) that operate as low as 0.65 V. Data pins A1 through A8 are designed to track V_{CCA} , which accepts any supply voltage from 0.65 V to 3.6 V. Data pins B1 through B8 are designed to track V_{CCB}, which accepts any supply voltage from 0.65 V to 3.6 V.

The SN74AXC8T245 device designed is for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level of the direction-control inputs (DIR1 and DIR2). The output-enable (OE) input is used to disable the outputs so the buses are effectively isolated.

The SN74AXC8T245 device is designed so the control pins (DIR and \overline{OE}) are referenced to V_{CCA}.

This device is fully specified for partial-power-down applications using Ioff. The Ioff circuitry disables the outputs when the device is powered down. This inhibits current backflow into the device which prevents damage to the device.

The V_{CC} isolation feature ensures that if either V_{CC} input supply is below 100 mV, all level shifter outputs are disabled and placed into a high-impedance state.

To ensure the high-impedance state of the level shifter I/Os during power up or power down, $\overline{\text{OE}}$ should be tied to V_{CCA} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Device Information⁽¹⁾

| PART NUMBER | PACKAGE | BODY SIZE (NOM) | | | |
|--------------------------------|------------|-------------------|--|--|--|
| SN74AXC8T245PW | TSSOP (24) | 4.40 mm × 7.80 mm | | | |
| SN74AXC8T245RHL | VQFN (24) | 3.50 mm × 5.50 mm | | | |
| SN74AXC8T245RJW ⁽²⁾ | UQFN (24) | 2.00 mm × 4.00 mm | | | |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

(2) Package preview only.

Typical Application Schematic

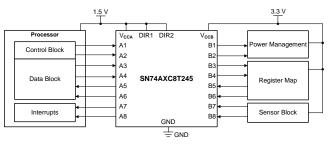




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4 Revision History

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| CI | hanges from Revision Original (March 2018) to Revision A | Page |
|----|--|------|
| • | Added RJW as a new package option (preview). | 1 |

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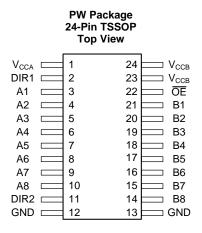
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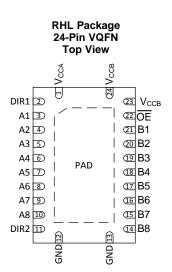
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8 Detailed Description 20

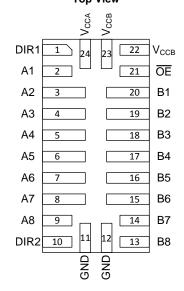


5 Pin Configuration and Functions





RJW Package⁽¹⁾ 24-Pin UQFN Top View



(1) Preview only.

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| | | | | Pin Functions | | | |
|------------------|---------|-----|-----|--|--|--|--|
| | PIN | | 1/0 | DECODIDITION | | | |
| NAME | PW, RHL | RJW | I/O | DESCRIPTION | | | |
| A1 | 3 | 2 | I/O | Input/output A1. Referenced to V _{CCA} . | | | |
| A2 | 4 | 3 | I/O | Input/output A2. Referenced to V _{CCA} . | | | |
| A3 | 5 | 4 | I/O | Input/output A3. Referenced to V _{CCA} . | | | |
| A4 | 6 | 5 | I/O | Input/output A4. Referenced to V _{CCA} . | | | |
| A5 | 7 | 6 | I/O | Input/output A5. Referenced to V _{CCA} . | | | |
| A6 | 8 | 7 | I/O | Input/output A6. Referenced to V _{CCA} . | | | |
| A7 | 9 | 8 | I/O | Input/output A7. Referenced to V _{CCA} . | | | |
| A8 | 10 | 9 | I/O | Input/output A8. Referenced to V _{CCA} . | | | |
| B1 | 21 | 20 | I/O | Input/output B1. Referenced to V _{CCB} . | | | |
| B2 | 20 | 19 | I/O | Input/output B2. Referenced to V _{CCB} . | | | |
| B3 | 19 | 18 | I/O | Input/output B3. Referenced to V _{CCB} . | | | |
| B4 | 18 | 17 | I/O | Input/output B4. Referenced to V _{CCB} . | | | |
| B5 | 17 | 16 | I/O | Input/output B5. Referenced to V _{CCB} . | | | |
| B6 | 16 | 15 | I/O | Input/output B6. Referenced to V _{CCB} . | | | |
| B7 | 15 | 14 | I/O | Input/output B7. Referenced to V _{CCB} . | | | |
| B8 | 14 | 13 | I/O | Input/output B8. Referenced to V _{CCB} . | | | |
| DIR1 | 2 | 1 | I | Direction-control signal. Referenced to V _{CCA} . | | | |
| DIR2 | 11 | 10 | I | Direction-control signal when both V _{CCA} and V _{CCB} \geq 1.4 V. Referenced to V _{CCA} . Tie to GND to maintain backward compatibility with SN74AVC8T245 device. | | | |
| | 12 | 11 | _ | Ground | | | |
| GND | 13 | 12 | _ | Ground | | | |
| OE | 22 | 21 | I | Output Enable. Pull to GND to enable all outputs. Pull to V_{CCA} to place all outputs in high-impedance mode. Referenced to V_{CCA} . | | | |
| V _{CCA} | 1 | 24 | _ | A-port supply voltage. 0.65 V \leq V _{CCA} \leq 3.6 V | | | |
| | 23 | 22 | _ | B-port supply voltage. 0.65 V \leq V _{CCB} \leq 3.6 V | | | |
| V _{CCB} | 24 | 23 | _ | B-port supply voltage. 0.65 V \leq V _{CCB} \leq 3.6 V | | | |



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6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

| | | MIN | MAX | UNIT | | |
|--|--------------------|------|------------------------|------|--|--|
| Supply voltage, V _{CCA} | | -0.5 | 4.2 | V | | |
| Supply voltage, V _{CCB} | | -0.5 | 4.2 | V | | |
| | I/O ports (A port) | -0.5 | 4.2 | | | |
| Input voltage, VI ⁽²⁾ | I/O ports (B port) | -0.5 | 4.2 | V | | |
| The high-impedance or power-off state, $V_0^{(2)}$ Toltage applied to any output the high-impedance or power-off state, $V_0^{(2)}$ Toltage applied to any output in the high or low state, $V_0^{(2)}^{(3)}$ apput clamp current, I_{IK} Dutput clamp current, I_{OK} Continuous output current, I_0 Continuous current through V_{CCA} , V_{CCB} , or GND | Control inputs | -0.5 | 4.2 | | | |
| Voltage applied to any output | A port | -0.5 | -0.5 4.2 | | | |
| in the high-impedance or power-off state, Vo ⁽²⁾ | B port | -0.5 | 4.2 | V | | |
| Valtage employed to any extruct in the high or law state $V(2)$ | A port | -0.5 | V _{CCA} + 0.2 | V | | |
| put voltage, $V_1^{(2)}$ pltage applied to any output the high-impedance or power-off state, $V_0^{(2)}$ pltage applied to any output in the high or low state, $V_0^{(2)}^{(3)}$ put clamp current, I_{IK} utput clamp current, I_{OK} ontinuous output current, I_0 ontinuous current through V_{CCA} , V_{CCB} , or GND unction Temperature, T_J | B port | -0.5 | V _{CCB} + 0.2 | v | | |
| Input clamp current, I _{IK} | V ₁ < 0 | -50 | | mA | | |
| Output clamp current, I _{OK} | V _O < 0 | -50 | | mA | | |
| Continuous output current, I _O | | -50 | 50 | mA | | |
| Continuous current through V _{CCA} , V _{CCB} , or GND | | -100 | 100 | mA | | |
| Junction Temperature, T _J | | | | | | |
| Storage temperature, T _{stg} | | -65 | 150 | °C | | |

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

(3) The output positive-voltage rating may be exceeded up to 4.2 V maximum if the output current rating is observed.

6.2 ESD Ratings

| | | | VALUE | UNIT | | |
|--|-------------------------|--|-------|------|--|--|
| V | Electroptotic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾ | | | | |
| V _(ESD) Electrostatic disch | Electrostatic discharge | Charged-device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾ | ±1000 | v | | |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

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6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted) $^{(1)(2)(3)}$

| | | | | MIN | MAX | UNIT | | |
|------------------|------------------------------------|--------------------------------|------------------------------------|-------------------------|--|------|--|--|
| V _{CCA} | Supply voltage | | | 0.65 | 3.6 | V | | |
| V _{CCB} | Supply voltage | | | 0.65 | 3.6 | V | | |
| | | | V _{CCI} = 0.65 V - 0.75 V | $V_{CCI} \times 0.70$ | | | | |
| | | | V _{CCI} = 0.76 V - 1 V | V _{CCI} × 0.70 | | | | |
| | | Data inputs | V _{CCI} = 1.1 V - 1.95 V | $V_{CCI} \times 0.65$ | | | | |
| | | | V _{CCI} = 2.3 V - 2.7 V | 1.6 | | | | |
| | Lligh lovel input veltage | | V _{CCI} = 3 V - 3.6 V | 2 | | V | | |
| V _{IH} | High-level input voltage | | V _{CCA} = 0.65 V - 0.75 V | $V_{CCA} \times 0.70$ | | v | | |
| | | Control inputs | V _{CCA} = 0.76 V - 1 V | $V_{CCA} \times 0.70$ | | | | |
| | | (DIR, OE) | V _{CCA} = 1.1 V - 1.95 V | $V_{CCA} \times 0.65$ | | | | |
| | | Referenced to V _{CCA} | V _{CCA} = 2.3 V - 2.7 V | 1.6 | | | | |
| | | | V _{CCA} = 3 V - 3.6 V | 2 | | | | |
| | | | V _{CCI} = 0.65 V - 0.75 V | | $V_{CCI} \times 0.30$ | | | |
| | | | V _{CCI} = 0.76 V - 1 V | | $V_{CCI} \times 0.30$ | | | |
| | | Data inputs | V _{CCI} = 1.1 V - 1.95 V | | $V_{CCI} \times 0.35$ | | | |
| | | | V _{CCI} = 2.3 V - 2.7 V | | 0.7 | | | |
| | | | V _{CCI} = 3 V - 3.6 V | | 0.8 | v | | |
| V _{IL} | Low-level input voltage | | V _{CCA} = 0.65 V - 0.75 V | | $V_{CCA} \times 0.30$ | v | | |
| | | Control inputs | V _{CCA} = 0.76 V - 1 V | | $V_{CCA} \times 0.30$ | | | |
| | | (DIR, OE) | V _{CCA} = 1.1 V - 1.95 V | | $V_{CCA} \times 0.35$ | | | |
| | | Referenced to V _{CCA} | V _{CCA} = 2.3 V - 2.7 V | | 0.7 | | | |
| | | | V _{CCA} = 3 V - 3.6 V | | 0.8 | 1 | | |
| VI | Input voltage ⁽³⁾ | | <u>.</u> | 0 | 3.6 | V | | |
| | | Active state | Active state | | | V | | |
| Vo | Output voltage | Tri-state | | 0 | V _{CCO} ⁽²⁾ 3.6 | v | | |
| Δt/Δv | Input transition rise or fall rate |) | | | 10 | ns/V | | |
| T _A | Operating free-air temperature | 9 | | -40 | 125 | °C | | |

(1)

(2)

 V_{CCI} is the V_{CC} associated with the input port. V_{CCO} is the V_{CC} associated with the output port. All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. See the *Implications of Slow or Floating CMOS Inputs* application report. (3)

6.4 Thermal Information

| | THERMAL METRIC | PW (TSSOP) | RHL (VQFN) | RJW (UQFN) | UNIT |
|-----------------------|--|------------|------------|------------|------|
| | | 24 PINS | 24 PINS | 24 PINS | |
| $R_{\theta JA}$ | Junction-to-ambient thermal resistance | 92.0 | 35.0 | 123.1 | °C/W |
| $R_{\theta JC(top)}$ | Junction-to-case (top) thermal resistance | 29.3 | 39.9 | 65.0 | °C/W |
| $R_{\theta JB}$ | Junction-to-board thermal resistance | 46.7 | 13.8 | 55.3 | °C/W |
| ΨJT | Junction-to-top characterization parameter | 1.5 | 0.3 | 3.9 | °C/W |
| ΨJB | Junction-to-board characterization parameter | 46.2 | 13.8 | 54.9 | °C/W |
| R _{0JC(bot)} | Junction-to-case (bottom) thermal resistance | N/A | 1.4 | N/A | °C/W |



6.5 Electrical Characteristics

Over recommended operating free-air temperature range (unless otherwise noted)⁽¹⁾

| P | | TEST | CONDITIONS | Ver | Vara | –40°C | to 85°C | | –40°C to 125°C | | | |
|-----------------|------------------------------------|--|--|------------------|------------------|------------------------|--------------------|------|-----------------|--------------------|------|------|
| PARAMETER | | 1231 | CONDITIONS | V _{CCA} | V _{CCB} | MIN | TYP ⁽²⁾ | ЛАХ | MIN | TYP ⁽²⁾ | MAX | UNIT |
| | | | I _{OH} = −100 μA | 0.7 V - 3.6 V | 0.7 V - 3.6 V | V _{CCO} – 0.1 | | | $V_{CCO} - 0.1$ | | | |
| | | | I _{OH} = -50 μA | 0.65 V | 0.65 V | 0.55 | | | 0.55 | | | |
| | | | I _{OH} = -200 μA | 0.76 V | 0.76 V | 0.58 | | | 0.58 | | | |
| | High-level | | I _{OH} = -500 μA | 0.85 V | 0.85 V | 0.65 | | | 0.65 | | | |
| V _{он} | output | $V_I=V_IH$ | I _{OH} = -3 mA | 1.1 V | 1.1 V | 0.85 | | | 0.85 | | | V |
| | voltage | | I _{OH} = -6 mA | 1.4 V | 1.4 V | 1.05 | | | 1.05 | | | |
| | | | I _{OH} = -8 mA | 1.65 V | 1.65 V | 1.2 | | | 1.2 | | | |
| | | | I _{OH} = -9 mA | 2.3 V | 2.3 V | 1.75 | | | 1.75 | | | |
| | | | I _{OH} = -12 mA | 3 V | 3 V | 2.3 | | | 2.3 | | | |
| | | | I _{OL} = 100 μA | 0.7 V - 3.6 V | 0.7 V - 3.6 V | | | 0.1 | | | 0.1 | |
| | | | I _{OL} = 50 μA | 0.65 V | 0.65 V | | | 0.1 | | | 0.1 | |
| | | | I _{OL} = 200 μA | 0.76 V | 0.76 V | | (| 0.18 | | | 0.18 | |
| | Low-level | | I _{OL} = 500 μA | 0.85 V | 0.85 V | | | 0.2 | | | 0.2 | |
| Vol | output | $V_{I} = V_{IL}$ | I _{OL} = 3 mA | 1.1 V | 1.1 V | | (| 0.25 | | | 0.25 | V |
| 02 | voltage | | $I_{OL} = 6 \text{ mA}$ | 1.4 V | 1.4 V | | (| 0.35 | | | 0.35 | |
| | | | $I_{OL} = 8 \text{ mA}$ | 1.65 V | 1.65 V | | (| 0.45 | | | 0.45 | |
| | | | I _{OL} = 9 mA | 2.3 V 2.3 V 0.55 | | 0.55 | | | 0.55 | | | |
| | | | $I_{OL} = 12 \text{ mA}$ | 3 V | 3 V | | | 0.7 | | | 0.7 | |
| 1 | Input leakage current | Control In V _I = V _{CCA} | puts (DIR, OE): | 0.65 V - 3.6 V | 0.65 V - 3.6 V | -0.5 | | 0.5 | -1 | | 1 | μA |
| | Partial power | A Port: | 0 V - 3.6 V | 0 V | 0 V - 3.6 V | -4 | | 4 | -8 | | 8 | |
| off | down current | B Port: V _I or V _O = | 0 V - 3.6 V | 0 V - 3.6 V | 0 V | -4 | | 4 | -8 | | 8 | μA |
| | High- impedance | A Port: $V_0 = V_{CC0}$ or GND, $V_1 = V_{CC1}$ or GND, $\overline{OE} = V_{1H}$ B Port: $V_0 = V_{CC0}$ or GND, $V_1 = V_{CC1}$ or GND, $\overline{OE} = V_{1H}$ | | 3.6 V | 3.6 V | -4 | | 4 | -8 | | 8 | |
| oz | state output current | | | 3.6 V | 3.6 V | -4 | | 4 | -8 | | 8 | - μΑ |
| | | | | 0.65 V - 3.6 V | 0.65 V - 3.6 V | | | 19 | | | 40 | |
| CCA | V _{CCA} supply current | $V_I = V_{CCI}$ | or GND, I _O = 0 mA | 0 V | 3.6 V | -2 | | | -12 | | | μA |
| | current | | | 3.6 V | 0 V | | | 12 | | | 25 | |
| | | | | 0.65 V - 3.6 V | 0.65 V - 3.6 V | | | 18 | | | 38 | |
| ССВ | V _{CCB} supply current | $V_I = V_{CCI}$ | or GND, I _O = 0 mA | 0 V | 3.6 V | | | 12 | | | 25 | μA |
| | current | | | 3.6 V | 0 V | -2 | | | -12 | | | |
| ССА ⊦ ССВ | Combined supply current | $V_{I} = V_{CCI}$ or GND, $I_{O} = 0$ mA | | 0.65 V - 3.6 V | 0.65 V - 3.6 V | | | 25 | | | 55 | μA |
| C _i | Input capacitance | Control In V _I = 3.3 V | puts (DIR, OE): or GND | 3.3 V | 3.3 V | | 4.5 | | | 4.5 | | pF |
| Cio | Data I/O capacitance | $\frac{Ports A ar}{OE} = V_{CC}$ 1 MHz -16 | nd B: _A , V _O = 1.65V DC + 6 dBm sine wave | 3.3 V | 3.3 V | | 5.7 | | | 5.7 | | pF |

(1) V_{CCO} is the V_{CC} associated with the output port. (2) All typical values are for $T_A = 25^{\circ}C$

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6.6 Switching Characteristics, $V_{CCA} = 0.7 V$

| | | | л то | | B-Port Supply Voltage (V _{CCB}) | | | | | | | | | | | |
|------------------|--------------|----|------|----------------|---|-----|-----|-----------------|---------|--------|---------|----------|---------|---------|---------|---------|
| P | PARAMETER | | | то | то | то | то | Test Conditions | 0.7 V ± | 0.05 V | 0.8 V ± | : 0.04 V | 0.9 V ± | 0.045 V | 1.2 V : | ± 0.1 V |
| | | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | | | | |
| | | А | в | -40°C to 85°C | 0.5 | 172 | 0.5 | 114 | 0.5 | 82 | 0.5 | 49 | | | | |
| | Propagation | A | Б | -40°C to 125°C | 0.5 | 172 | 0.5 | 114 | 0.5 | 82 | 0.5 | 49 | ~~ | | | |
| t _{pd} | delay | В | ^ | -40°C to 85°C | 0.5 | 172 | 0.5 | 153 | 0.5 | 126 | 0.5 | 88 | ns | | | |
| | | Б | A | -40°C to 125°C | 0.5 | 172 | 0.5 | 153 | 0.5 | 126 | 0.5 | 88 | | | | |
| | | ŌĒ | | А | -40°C to 85°C | 0.5 | 192 | 0.5 | 192 | 0.5 | 192 | 0.5 | 192 | | | |
| | Disable time | | | -40°C to 125°C | 0.5 | 195 | 0.5 | 195 | 0.5 | 195 | 0.5 | 195 | | | | |
| t _{dis} | Disable time | | В | -40°C to 85°C | 0.5 | 156 | 0.5 | 129 | 0.5 | 118 | 0.5 | 120 | ns | | | |
| | | OE | в | -40°C to 125°C | 0.5 | 157 | 0.5 | 129 | 0.5 | 120 | 0.5 | 122 | | | | |
| | | OE | • | -40°C to 85°C | 0.5 | 237 | 0.5 | 237 | 0.5 | 237 | 0.5 | 237 | | | | |
| | Enable time | UE | A | -40°C to 125°C | 0.5 | 237 | 0.5 | 237 | 0.5 | 237 | 0.5 | 237 | | | | |
| t _{en} | | OE | l | P | -40°C to 85°C | 0.5 | 223 | 0.5 | 145 | 0.5 | 106 | 0.5 | 74 | ns | | |
| | | UE | В | -40°C to 125°C | 0.5 | 223 | 0.5 | 145 | 0.5 | 106 | 0.5 | 74 | | | | |

| | | | | | | | | B-Port | Supply V | /oltage (V | _{ссв}) | | | | |
|------------------|-------------|------|----|-----------------|----------------|---------------|----------------|--------|---------------|------------|------------------|-----|------|-----|----|
| P | ARAMETER | FROM | то | Test Conditions | 1.5 V ± 0.1 V | | 1.8 V ± 0.15 V | | 2.5 V ± 0.2 V | | 3.3 V ± 0.3 V | | UNIT | | |
| | | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | | | |
| | | А | В | –40°C to 85°C | 0.5 | 46 | 0.5 | 49 | 0.5 | 61 | 0.5 | 142 | | | |
| | Propagation | A | D | -40°C to 125°C | 0.5 | 46 | 0.5 | 49 | 0.5 | 61 | 0.5 | 142 | | | |
| t _{pd} | delay | В | • | -40°C to 85°C | 0.5 | 83 | 0.5 | 82 | 0.5 | 81 | 0.5 | 81 | ns | | |
| | | | в | A | -40°C to 125°C | 0.5 | 83 | 0.5 | 82 | 0.5 | 81 | 0.5 | 81 | | |
| | Disable | ŌĒ | | ~ | –40°C to 85°C | 0.5 | 192 | 0.5 | 192 | 0.5 | 192 | 0.5 | 192 | | |
| | | | A | -40°C to 125°C | 0.5 | 195 | 0.5 | 195 | 0.5 | 195 | 0.5 | 195 | 20 | | |
| t _{dis} | time | | | OF | В | -40°C to 85°C | 0.5 | 69 | 0.5 | 66 | 0.5 | 67 | 0.5 | 150 | ns |
| | | OE | в | -40°C to 125°C | 0.5 | 70 | 0.5 | 67 | 0.5 | 67 | 0.5 | 150 | | | |
| | | OE | А | –40°C to 85°C | 0.5 | 237 | 0.5 | 237 | 0.5 | 237 | 0.5 | 237 | | | |
| | Enable time | OE | А | -40°C to 125°C | 0.5 | 237 | 0.5 | 237 | 0.5 | 237 | 0.5 | 237 | 20 | | |
| t _{en} | | | OE | В | -40°C to 85°C | 0.5 | 68 | 0.5 | 69 | 0.5 | 84 | 0.5 | 552 | ns | |
| | | UE | D | -40°C to 125°C | 0.5 | 68 | 0.5 | 69 | 0.5 | 84 | 0.5 | 552 | | | |



6.7 Switching Characteristics, $V_{CCA} = 0.8 V$

| | | | | | | | B-Port | Supply V | oltage (V | ссв) | | | |
|------------------|--------------|------|----|-----------------|---------|--------|---------|----------|-----------|---------|---------|---------|------|
| P | ARAMETER | FROM | то | Test Conditions | 0.7 V ± | 0.05 V | 0.8 V ± | ± 0.04 V | 0.9 V ± | 0.045 V | 1.2 V : | ± 0.1 V | UNIT |
| | | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | | А | в | -40°C to 85°C | 0.5 | 153 | 0.5 | 95 | 0.5 | 62 | 0.5 | 32 | |
| | Propagation | A | Б | -40°C to 125°C | 0.5 | 153 | 0.5 | 95 | 0.5 | 62 | 0.5 | 32 | 20 |
| t _{pd} | delay | В | ^ | -40°C to 85°C | 0.5 | 114 | 0.5 | 95 | 0.5 | 78 | 0.5 | 52 | ns |
| | | Б | A | -40°C to 125°C | 0.5 | 114 | 0.5 | 95 | 0.5 | 78 | 0.5 | 52 | |
| | | OE | А | -40°C to 85°C | 0.5 | 101 | 0.5 | 101 | 0.5 | 101 | 0.5 | 101 | |
| | Diachla time | UE | А | -40°C to 125°C | 0.5 | 103 | 0.5 | 103 | 0.5 | 103 | 0.5 | 103 | |
| t _{dis} | Disable time | OE | в | -40°C to 85°C | 0.5 | 141 | 0.5 | 114 | 0.5 | 104 | 0.5 | 106 | ns |
| | | UE | Б | -40°C to 125°C | 0.5 | 142 | 0.5 | 115 | 0.5 | 106 | 0.5 | 109 | |
| | | OE | А | -40°C to 85°C | 0.5 | 102 | 0.5 | 102 | 0.5 | 102 | 0.5 | 102 | |
| | Enable time | UE | А | -40°C to 125°C | 0.5 | 102 | 0.5 | 102 | 0.5 | 102 | 0.5 | 102 | 20 |
| t _{en} | | OE | В | -40°C to 85°C | 0.5 | 202 | 0.5 | 124 | 0.5 | 86 | 0.5 | 52 | ns |
| | | UE | В | -40°C to 125°C | 0.5 | 202 | 0.5 | 124 | 0.5 | 86 | 0.5 | 52 | |

| | | | | | | | B-Port | Supply V | oltage (V | ссв) | | | |
|------------------|-------------|------|----|------------------------|-------|---------|---------|----------|-----------|---------|---------|---------|------|
| P/ | ARAMETER | FROM | то | Test Conditions | 1.5 V | ± 0.1 V | 1.8 V ± | ± 0.15 V | 2.5 V | ± 0.2 V | 3.3 V : | ± 0.3 V | UNIT |
| | | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | | А | В | –40°C to 85°C | 0.5 | 26 | 0.5 | 25 | 0.5 | 25 | 0.5 | 35 | |
| | Propagation | A | D | -40°C to 125°C | 0.5 | 26 | 0.5 | 25 | 0.5 | 25 | 0.5 | 35 | 20 |
| t _{pd} | delay | В | ^ | –40°C to 85°C | 0.5 | 42 | 0.5 | 41 | 0.5 | 40 | 0.5 | 40 | ns |
| | | Б | A | –40°C to 125°C | 0.5 | 42 | 0.5 | 41 | 0.5 | 40 | 0.5 | 40 | |
| | | OE | А | –40°C to 85°C | 0.5 | 101 | 0.5 | 101 | 0.5 | 101 | 0.5 | 101 | |
| | Disable | UE | А | -40°C to 125°C | 0.5 | 103 | 0.5 | 103 | 0.5 | 103 | 0.5 | 103 | 20 |
| t _{dis} | time | OE | В | –40°C to 85°C | 0.5 | 55 | 0.5 | 51 | 0.5 | 49 | 0.5 | 51 | ns |
| | | UE | D | –40°C to 125°C | 0.5 | 57 | 0.5 | 53 | 0.5 | 50 | 0.5 | 52 | |
| | | OE | А | –40°C to 85°C | 0.5 | 102 | 0.5 | 102 | 0.5 | 102 | 0.5 | 102 | |
| | Enchla time | UE | А | -40°C to 125°C | 0.5 | 102 | 0.5 | 102 | 0.5 | 102 | 0.5 | 102 | 20 |
| t _{en} | Enable time | OE | В | –40°C to 85°C | 0.5 | 44 | 0.5 | 43 | 0.5 | 45 | 0.5 | 58 | ns |
| | | UE | D | –40°C to 125°C | 0.5 | 44 | 0.5 | 43 | 0.5 | 45 | 0.5 | 58 | |

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6.8 Switching Characteristics, V_{CCA} = 0.9 V

| | | | | | | | B-Port | Supply V | oltage (V | ссв) | | | |
|------------------|--------------|------|----|-----------------|---------|--------|---------|----------|-----------|---------|---------|---------|------|
| P | ARAMETER | FROM | то | Test Conditions | 0.7 V ± | 0.05 V | 0.8 V ± | : 0.04 V | 0.9 V ± | 0.045 V | 1.2 V : | ± 0.1 V | UNIT |
| | | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | | А | в | -40°C to 85°C | 0.5 | 127 | 0.5 | 78 | 0.5 | 52 | 0.5 | 23 | |
| | Propagation | A | Б | -40°C to 125°C | 0.5 | 127 | 0.5 | 78 | 0.5 | 52 | 0.5 | 23 | ~~ |
| t _{pd} | delay | В | ^ | -40°C to 85°C | 0.5 | 82 | 0.5 | 63 | 0.5 | 52 | 0.5 | 39 | ns |
| | | Б | A | -40°C to 125°C | 0.5 | 82 | 0.5 | 63 | 0.5 | 52 | 0.5 | 39 | |
| | | OE | А | -40°C to 85°C | 0.5 | 125 | 0.5 | 125 | 0.5 | 125 | 0.5 | 125 | |
| | Dischla time | 0E | A | -40°C to 125°C | 0.5 | 128 | 0.5 | 128 | 0.5 | 128 | 0.5 | 128 | ~~ |
| t _{dis} | Disable time | OE | в | -40°C to 85°C | 0.5 | 131 | 0.5 | 105 | 0.5 | 96 | 0.5 | 99 | ns |
| | | UE | Б | -40°C to 125°C | 0.5 | 133 | 0.5 | 107 | 0.5 | 98 | 0.5 | 101 | |
| | | OE | А | -40°C to 85°C | 0.5 | 124 | 0.5 | 124 | 0.5 | 124 | 0.5 | 124 | |
| | Enchla time | UE | A | -40°C to 125°C | 0.5 | 128 | 0.5 | 128 | 0.5 | 128 | 0.5 | 128 | ~~ |
| t _{en} | Enable time | OE | В | -40°C to 85°C | 0.5 | 191 | 0.5 | 113 | 0.5 | 75 | 0.5 | 41 | ns |
| | | UE | В | –40°C to 125°C | 0.5 | 191 | 0.5 | 113 | 0.5 | 75 | 0.5 | 41 | |

| | | | | | | | B-Port | Supply V | /oltage (V | ссв) | | | |
|------------------|-------------|------|----|-----------------|-------|---------|---------|----------|------------|---------|---------|---------|------|
| P | ARAMETER | FROM | то | Test Conditions | 1.5 V | ± 0.1 V | 1.8 V ± | ± 0.15 V | 2.5 V | ± 0.2 V | 3.3 V : | ± 0.3 V | UNIT |
| | | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | | А | в | –40°C to 85°C | 0.5 | 17 | 0.5 | 15 | 0.5 | 14 | 0.5 | 17 | |
| | Propagation | A | D | -40°C to 125°C | 0.5 | 17 | 0.5 | 15 | 0.5 | 14 | 0.5 | 17 | 20 |
| t _{pd} | delay | В | ^ | –40°C to 85°C | 0.5 | 28 | 0.5 | 24 | 0.5 | 22 | 0.5 | 22 | ns |
| | | Б | A | -40°C to 125°C | 0.5 | 28 | 0.5 | 24 | 0.5 | 22 | 0.5 | 22 | |
| | | OE | А | –40°C to 85°C | 0.5 | 125 | 0.5 | 125 | 0.5 | 125 | 0.5 | 125 | |
| | Disable | UE | А | -40°C to 125°C | 0.5 | 128 | 0.5 | 128 | 0.5 | 128 | 0.5 | 128 | 20 |
| t _{dis} | time | OE | в | –40°C to 85°C | 0.5 | 47 | 0.5 | 44 | 0.5 | 40 | 0.5 | 73 | ns |
| | | UE | D | -40°C to 125°C | 0.5 | 50 | 0.5 | 46 | 0.5 | 42 | 0.5 | 73 | |
| | | OE | А | –40°C to 85°C | 0.5 | 124 | 0.5 | 124 | 0.5 | 124 | 0.5 | 124 | |
| | Enchla time | UE | А | -40°C to 125°C | 0.5 | 128 | 0.5 | 128 | 0.5 | 128 | 0.5 | 128 | 20 |
| t _{en} | Enable time | OE | в | –40°C to 85°C | 0.5 | 34 | 0.5 | 32 | 0.5 | 31 | 0.5 | 35 | ns |
| | | UE | D | –40°C to 125°C | 0.5 | 34 | 0.5 | 32 | 0.5 | 31 | 0.5 | 35 | |



6.9 Switching Characteristics, $V_{CCA} = 1.2 V$

| | | | | | | | B-Port | Supply V | oltage (V | ссв) | | | |
|------------------|--------------|------|----|-----------------|---------|----------|---------|----------|-----------|---------|---------|---------|------|
| P | ARAMETER | FROM | то | Test Conditions | 0.7 V ± | : 0.05 V | 0.8 V ± | ± 0.04 V | 0.9 V ± | 0.045 V | 1.2 V : | ± 0.1 V | UNIT |
| | | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | | А | В | -40°C to 85°C | 0.5 | 88 | 0.5 | 52 | 0.5 | 39 | 0.5 | 15 | |
| | Propagation | A | Б | -40°C to 125°C | 0.5 | 88 | 0.5 | 52 | 0.5 | 39 | 0.5 | 15 | - |
| t _{pd} | delay | В | А | -40°C to 85°C | 0.5 | 49 | 0.5 | 32 | 0.5 | 23 | 0.5 | 15 | ns |
| | | Б | A | -40°C to 125°C | 0.5 | 49 | 0.5 | 32 | 0.5 | 23 | 0.5 | 15 | |
| | | OE | А | -40°C to 85°C | 0.5 | 87 | 0.5 | 87 | 0.5 | 87 | 0.5 | 87 | |
| | Disable time | UE | A | -40°C to 125°C | 0.5 | 91 | 0.5 | 91 | 0.5 | 91 | 0.5 | 91 | |
| t _{dis} | Disable time | OE | в | -40°C to 85°C | 0.5 | 119 | 0.5 | 94 | 0.5 | 85 | 0.5 | 89 | ns |
| | | UE | Б | -40°C to 125°C | 0.5 | 121 | 0.5 | 96 | 0.5 | 88 | 0.5 | 93 | |
| | | OE | А | -40°C to 85°C | 0.5 | 34 | 0.5 | 34 | 0.5 | 34 | 0.5 | 34 | |
| | Enchla time | UE | A | -40°C to 125°C | 0.5 | 36 | 0.5 | 36 | 0.5 | 36 | 0.5 | 36 | - |
| t _{en} | Enable time | OE | в | -40°C to 85°C | 0.5 | 168 | 0.5 | 98 | 0.5 | 61 | 0.5 | 29 | ns |
| | | UE | В | -40°C to 125°C | 0.5 | 168 | 0.5 | 98 | 0.5 | 61 | 0.5 | 30 | |

| | | | | | | | B-Port | Supply V | oltage (V | ссв) | | | |
|------------------|-------------|------|----|-----------------|-------|---------|---------|----------|-----------|---------|---------|---------|------|
| P | ARAMETER | FROM | то | Test Conditions | 1.5 V | ± 0.1 V | 1.8 V ± | - 0.15 V | 2.5 V | ± 0.2 V | 3.3 V : | ± 0.3 V | UNIT |
| | | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | | А | в | –40°C to 85°C | 0.5 | 10 | 0.5 | 9 | 0.5 | 7 | 0.5 | 7 | |
| | Propagation | A | D | -40°C to 125°C | 0.5 | 10 | 0.5 | 9 | 0.5 | 7 | 0.5 | 8 | 20 |
| t _{pd} | delay | В | ^ | –40°C to 85°C | 0.5 | 13 | 0.5 | 11 | 0.5 | 8 | 0.5 | 7 | ns |
| | | Б | A | -40°C to 125°C | 0.5 | 13 | 0.5 | 11 | 0.5 | 8 | 0.5 | 7 | |
| | | OE | ^ | –40°C to 85°C | 0.5 | 87 | 0.5 | 87 | 0.5 | 87 | 0.5 | 87 | |
| | Disable | UE | A | -40°C to 125°C | 0.5 | 91 | 0.5 | 91 | 0.5 | 91 | 0.5 | 91 | 20 |
| t _{dis} | time | OE | в | –40°C to 85°C | 0.5 | 38 | 0.5 | 35 | 0.5 | 31 | 0.5 | 29 | ns |
| | | UE | D | -40°C to 125°C | 0.5 | 41 | 0.5 | 38 | 0.5 | 33 | 0.5 | 31 | |
| | | OE | А | –40°C to 85°C | 0.5 | 34 | 0.5 | 34 | 0.5 | 34 | 0.5 | 34 | |
| | Enchla time | UE | A | -40°C to 125°C | 0.5 | 36 | 0.5 | 36 | 0.5 | 36 | 0.5 | 36 | 20 |
| t _{en} | Enable time | OE | в | –40°C to 85°C | 0.5 | 22 | 0.5 | 19 | 0.5 | 17 | 0.5 | 17 | ns |
| | | UE | D | –40°C to 125°C | 0.5 | 23 | 0.5 | 20 | 0.5 | 18 | 0.5 | 18 | |

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6.10 Switching Characteristics, V_{CCA} = 1.5 V

| | | | | | | | B-Port | Supply V | oltage (V | ссв) | | | |
|------------------|--------------|------|----|-----------------|---------|--------|---------|----------|-----------|---------|---------|---------|------|
| P | ARAMETER | FROM | то | Test Conditions | 0.7 V ± | 0.05 V | 0.8 V ± | 0.04 V | 0.9 V ± | 0.045 V | 1.2 V : | ± 0.1 V | UNIT |
| | | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | | А | в | -40°C to 85°C | 0.5 | 84 | 0.5 | 42 | 0.5 | 28 | 0.5 | 13 | |
| | Propagation | A | Б | -40°C to 125°C | 0.5 | 84 | 0.5 | 42 | 0.5 | 28 | 0.5 | 13 | |
| t _{pd} | delay | В | А | -40°C to 85°C | 0.5 | 46 | 0.5 | 26 | 0.5 | 17 | 0.5 | 10 | ns |
| | | Б | A | -40°C to 125°C | 0.5 | 46 | 0.5 | 26 | 0.5 | 17 | 0.5 | 10 | |
| | | OE | А | -40°C to 85°C | 0.5 | 34 | 0.5 | 34 | 0.5 | 34 | 0.5 | 34 | |
| | Disable time | UE | A | -40°C to 125°C | 0.5 | 37 | 0.5 | 37 | 0.5 | 37 | 0.5 | 37 | |
| t _{dis} | Disable time | OE | в | -40°C to 85°C | 0.5 | 115 | 0.5 | 89 | 0.5 | 80 | 0.5 | 85 | ns |
| | | UE | Б | -40°C to 125°C | 0.5 | 117 | 0.5 | 91 | 0.5 | 83 | 0.5 | 89 | |
| | | OE | А | -40°C to 85°C | 0.5 | 21 | 0.5 | 21 | 0.5 | 21 | 0.5 | 21 | |
| | Enchla time | UE | A | -40°C to 125°C | 0.5 | 23 | 0.5 | 23 | 0.5 | 23 | 0.5 | 23 | |
| t _{en} | Enable time | OE | В | -40°C to 85°C | 0.5 | 159 | 0.5 | 90 | 0.5 | 55 | 0.5 | 24 | ns |
| | | UE | В | -40°C to 125°C | 0.5 | 159 | 0.5 | 90 | 0.5 | 55 | 0.5 | 25 | |

| | | | | | | | B-Port | Supply V | oltage (V | ссв) | | | |
|------------------|-------------|------|----|-----------------|-------|---------|---------|----------|-----------|---------|---------|---------|------|
| P/ | ARAMETER | FROM | то | Test Conditions | 1.5 V | ± 0.1 V | 1.8 V ± | ± 0.15 V | 2.5 V | ± 0.2 V | 3.3 V : | ± 0.3 V | UNIT |
| | | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | | А | в | –40°C to 85°C | 0.5 | 9 | 0.5 | 7 | 0.5 | 6 | 0.5 | 5 | |
| | Propagation | A | Б | –40°C to 125°C | 0.5 | 9 | 0.5 | 7 | 0.5 | 6 | 0.5 | 6 | ~~ |
| t _{pd} | delay | В | • | -40°C to 85°C | 0.5 | 9 | 0.5 | 7 | 0.5 | 6 | 0.5 | 5 | ns |
| | | В | A | -40°C to 125°C | 0.5 | 9 | 0.5 | 8 | 0.5 | 6 | 0.5 | 5 | |
| | | OE | А | -40°C to 85°C | 0.5 | 34 | 0.5 | 34 | 0.5 | 34 | 0.5 | 34 | |
| | Disable | UE | А | -40°C to 125°C | 0.5 | 37 | 0.5 | 37 | 0.5 | 37 | 0.5 | 37 | ~~ |
| t _{dis} | time | OE | в | -40°C to 85°C | 0.5 | 35 | 0.5 | 31 | 0.5 | 28 | 0.5 | 25 | ns |
| | | OE | в | -40°C to 125°C | 0.5 | 38 | 0.5 | 34 | 0.5 | 31 | 0.5 | 27 | |
| | | OE | А | -40°C to 85°C | 0.5 | 21 | 0.5 | 21 | 0.5 | 21 | 0.5 | 21 | |
| | Enchla time | UE | А | -40°C to 125°C | 0.5 | 23 | 0.5 | 23 | 0.5 | 23 | 0.5 | 23 | ~~ |
| t _{en} | Enable time | OE | в | -40°C to 85°C | 0.5 | 17 | 0.5 | 15 | 0.5 | 12 | 0.5 | 11 | ns |
| | | UE | D | –40°C to 125°C | 0.5 | 18 | 0.5 | 15 | 0.5 | 13 | 0.5 | 12 | |



6.11 Switching Characteristics, V_{CCA} = 1.8 V

| | | | | | | | B-Port | Supply V | oltage (V | ссв) | | | |
|------------------|--------------|------|----|-----------------|---------|--------|---------|----------|-----------|---------|---------|---------|------|
| P | ARAMETER | FROM | то | Test Conditions | 0.7 V ± | 0.05 V | 0.8 V ± | ± 0.04 V | 0.9 V ± | 0.045 V | 1.2 V : | ± 0.1 V | UNIT |
| | | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | | А | в | -40°C to 85°C | 0.5 | 82 | 0.5 | 41 | 0.5 | 24 | 0.5 | 11 | |
| | Propagation | A | Б | -40°C to 125°C | 0.5 | 82 | 0.5 | 41 | 0.5 | 24 | 0.5 | 11 | |
| t _{pd} | delay | В | А | -40°C to 85°C | 0.5 | 49 | 0.5 | 25 | 0.5 | 15 | 0.5 | 9 | ns |
| | | Б | A | -40°C to 125°C | 0.5 | 49 | 0.5 | 25 | 0.5 | 15 | 0.5 | 9 | |
| | | OE | А | -40°C to 85°C | 0.5 | 37 | 0.5 | 37 | 0.5 | 37 | 0.5 | 37 | |
| | Disable time | UE | A | -40°C to 125°C | 0.5 | 40 | 0.5 | 40 | 0.5 | 40 | 0.5 | 40 | |
| t _{dis} | Disable time | OE | В | -40°C to 85°C | 0.5 | 113 | 0.5 | 87 | 0.5 | 78 | 0.5 | 83 | ns |
| | | UE | Б | -40°C to 125°C | 0.5 | 115 | 0.5 | 89 | 0.5 | 81 | 0.5 | 87 | |
| | | OE | А | -40°C to 85°C | 0.5 | 17 | 0.5 | 17 | 0.5 | 17 | 0.5 | 17 | |
| + | Enable time | UE | А | -40°C to 125°C | 0.5 | 19 | 0.5 | 19 | 0.5 | 19 | 0.5 | 19 | - |
| t _{en} | | OE | В | -40°C to 85°C | 0.5 | 157 | 0.5 | 88 | 0.5 | 54 | 0.5 | 23 | ns |
| | | UE | В | -40°C to 125°C | 0.5 | 157 | 0.5 | 88 | 0.5 | 54 | 0.5 | 23 | |

| | | | | | | | B-Port | Supply V | oltage (V | _{ссв}) | | | |
|------------------|-------------|------|----|-----------------|-------|---------|---------|----------|-----------|------------------|---------|---------|------|
| P | ARAMETER | FROM | то | Test Conditions | 1.5 V | ± 0.1 V | 1.8 V ± | - 0.15 V | 2.5 V | ± 0.2 V | 3.3 V : | ± 0.3 V | UNIT |
| | | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | | А | в | –40°C to 85°C | 0.5 | 8 | 0.5 | 6 | 0.5 | 5 | 0.5 | 5 | |
| | Propagation | A | D | -40°C to 125°C | 0.5 | 8 | 0.5 | 7 | 0.5 | 6 | 0.5 | 5 | 20 |
| t _{pd} | delay | В | ~ | –40°C to 85°C | 0.5 | 7 | 0.5 | 6 | 0.5 | 5 | 0.5 | 4 | ns |
| | | Б | A | -40°C to 125°C | 0.5 | 7 | 0.5 | 7 | 0.5 | 5 | 0.5 | 4 | |
| | | OE | А | –40°C to 85°C | 0.5 | 37 | 0.5 | 37 | 0.5 | 37 | 0.5 | 37 | |
| | Disable | UE | А | -40°C to 125°C | 0.5 | 40 | 0.5 | 40 | 0.5 | 40 | 0.5 | 40 | 20 |
| t _{dis} | time | OE | в | –40°C to 85°C | 0.5 | 33 | 0.5 | 30 | 0.5 | 27 | 0.5 | 57 | ns |
| | | UE | D | -40°C to 125°C | 0.5 | 36 | 0.5 | 33 | 0.5 | 29 | 0.5 | 60 | |
| | | OE | А | –40°C to 85°C | 0.5 | 17 | 0.5 | 17 | 0.5 | 17 | 0.5 | 17 | |
| | Enable time | UE | А | -40°C to 125°C | 0.5 | 19 | 0.5 | 19 | 0.5 | 19 | 0.5 | 19 | 20 |
| t _{en} | | OE | в | –40°C to 85°C | 0.5 | 15 | 0.5 | 13 | 0.5 | 10 | 0.5 | 9 | ns |
| | | UE | D | -40°C to 125°C | 0.5 | 16 | 0.5 | 14 | 0.5 | 11 | 0.5 | 10 | |

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6.12 Switching Characteristics, V_{CCA} = 2.5 V

| | | | | | | | B-Port | Supply V | oltage (V | ссв) | | | |
|------------------|--------------|------|----|-----------------|---------|--------|---------|----------|-----------|---------|---------|---------|------|
| P | ARAMETER | FROM | то | Test Conditions | 0.7 V ± | 0.05 V | 0.8 V ± | : 0.04 V | 0.9 V ± | 0.045 V | 1.2 V : | ± 0.1 V | UNIT |
| | | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | | А | в | -40°C to 85°C | 0.5 | 81 | 0.5 | 40 | 0.5 | 22 | 0.5 | 8 | |
| | Propagation | A | Б | -40°C to 125°C | 0.5 | 81 | 0.5 | 40 | 0.5 | 22 | 0.5 | 8 | |
| t _{pd} | delay | В | А | -40°C to 85°C | 0.5 | 61 | 0.5 | 25 | 0.5 | 14 | 0.5 | 7 | ns |
| | | Б | A | -40°C to 125°C | 0.5 | 61 | 0.5 | 25 | 0.5 | 14 | 0.5 | 7 | |
| | | OE | А | -40°C to 85°C | 0.5 | 25 | 0.5 | 25 | 0.5 | 25 | 0.5 | 25 | |
| | Disable time | UE | A | -40°C to 125°C | 0.5 | 28 | 0.5 | 28 | 0.5 | 28 | 0.5 | 28 | |
| t _{dis} | Disable time | OE | в | -40°C to 85°C | 0.5 | 111 | 0.5 | 85 | 0.5 | 76 | 0.5 | 81 | ns |
| | | OE | В | -40°C to 125°C | 0.5 | 113 | 0.5 | 87 | 0.5 | 78 | 0.5 | 84 | |
| | | OE | А | -40°C to 85°C | 0.5 | 11 | 0.5 | 11 | 0.5 | 11 | 0.5 | 11 | |
| | Enchla time | UE | A | -40°C to 125°C | 0.5 | 12 | 0.5 | 12 | 0.5 | 12 | 0.5 | 12 | |
| t _{en} | Enable time | OE | В | -40°C to 85°C | 0.5 | 155 | 0.5 | 86 | 0.5 | 52 | 0.5 | 21 | ns |
| | | UE | В | -40°C to 125°C | 0.5 | 155 | 0.5 | 86 | 0.5 | 52 | 0.5 | 21 | |

| | | | | | | | B-Port | Supply V | oltage (V | ссв) | | | |
|------------------|-------------|------|----|-----------------|-------|---------|---------|----------|-----------|---------|---------|---------|------|
| P/ | ARAMETER | FROM | то | Test Conditions | 1.5 V | ± 0.1 V | 1.8 V ± | - 0.15 V | 2.5 V | ± 0.2 V | 3.3 V : | ± 0.3 V | UNIT |
| | | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | | А | в | -40°C to 85°C | 0.5 | 6 | 0.5 | 5 | 0.5 | 4 | 0.5 | 4 | |
| | Propagation | A | Б | -40°C to 125°C | 0.5 | 6 | 0.5 | 5 | 0.5 | 5 | 0.5 | 4 | |
| t _{pd} | delay | В | • | -40°C to 85°C | 0.5 | 6 | 0.5 | 5 | 0.5 | 4 | 0.5 | 4 | ns |
| | | в | A | –40°C to 125°C | 0.5 | 6 | 0.5 | 5 | 0.5 | 5 | 0.5 | 4 | |
| | | OE | А | -40°C to 85°C | 0.5 | 25 | 0.5 | 25 | 0.5 | 25 | 0.5 | 25 | |
| | Disable | UE | А | –40°C to 125°C | 0.5 | 28 | 0.5 | 28 | 0.5 | 28 | 0.5 | 28 | 20 |
| t _{dis} | time | OE | в | -40°C to 85°C | 0.5 | 31 | 0.5 | 28 | 0.5 | 25 | 0.5 | 23 | ns |
| | | UE | Б | –40°C to 125°C | 0.5 | 34 | 0.5 | 31 | 0.5 | 28 | 0.5 | 25 | |
| | | OE | А | -40°C to 85°C | 0.5 | 11 | 0.5 | 11 | 0.5 | 11 | 0.5 | 11 | |
| | Enchle time | UE | A | -40°C to 125°C | 0.5 | 12 | 0.5 | 12 | 0.5 | 12 | 0.5 | 12 | ~~ |
| t _{en} | Enable time | OE | в | -40°C to 85°C | 0.5 | 14 | 0.5 | 11 | 0.5 | 9 | 0.5 | 7 | ns |
| | | UE | D | –40°C to 125°C | 0.5 | 14 | 0.5 | 12 | 0.5 | 9 | 0.5 | 8 | |



6.13 Switching Characteristics, V_{CCA} = 3.3 V

| | | | | | | | B-Port | Supply V | oltage (V | ссв) | | | | | |
|------------------|---------------|------|-----|-----------------|----------------|---------------|----------------|----------|-----------|---------|---------------|-----|------|----|----|
| P | ARAMETER | FROM | то | Test Conditions | 0.7 V ± 0.05 V | | 0.8 V ± 0.04 V | | 0.9 V ± | 0.045 V | 1.2 V ± 0.1 V | | UNIT | | |
| | | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | | | |
| | ↓ Propagation | А | в | -40°C to 85°C | 0.5 | 81 | 0.5 | 40 | 0.5 | 22 | 0.5 | 7 | | | |
| | | A | A D | -40°C to 125°C | 0.5 | 81 | 0.5 | 40 | 0.5 | 22 | 0.5 | 7 | 20 | | |
| | delay | В | Р | Р | ٨ | -40°C to 85°C | 0.5 | 142 | 0.5 | 35 | 0.5 | 17 | 0.5 | 7 | ns |
| | | | A | -40°C to 125°C | 0.5 | 142 | 0.5 | 35 | 0.5 | 17 | 0.5 | 8 | | | |
| | | ŌĒ | А | -40°C to 85°C | 0.5 | 22 | 0.5 | 22 | 0.5 | 22 | 0.5 | 22 | | | |
| | Disable time | | A | -40°C to 125°C | 0.5 | 24 | 0.5 | 24 | 0.5 | 24 | 0.5 | 24 | | | |
| t _{dis} | Disable time | | OE | D | -40°C to 85°C | 0.5 | 111 | 0.5 | 84 | 0.5 | 75 | 0.5 | 80 | ns | |
| | | OE | В | -40°C to 125°C | 0.5 | 113 | 0.5 | 86 | 0.5 | 78 | 0.5 | 83 | | | |
| | | OE | | -40°C to 85°C | 0.5 | 9 | 0.5 | 9 | 0.5 | 9 | 0.5 | 9 | | | |
| | Enchla first | UE | A | -40°C to 125°C | 0.5 | 10 | 0.5 | 10 | 0.5 | 10 | 0.5 | 10 | | | |
| t _{en} | Enable time | OE | P | -40°C to 85°C | 0.5 | 154 | 0.5 | 86 | 0.5 | 51 | 0.5 | 20 | ns | | |
| | | UE | В | -40°C to 125°C | 0.5 | 154 | 0.5 | 86 | 0.5 | 51 | 0.5 | 20 | | | |

| | | | | | | | B-Port | Supply V | oltage (V | ссв) | | | | |
|------------------|-------------|----------|---------------|-----------------|----------------|-----|---------|----------------|-----------|---------------|-----|---------------|----|--|
| P | ARAMETER | FROM | то | Test Conditions | 1.5 V ± 0.1 V | | 1.8 V ± | 1.8 V ± 0.15 V | | 2.5 V ± 0.2 V | | 3.3 V ± 0.3 V | | |
| | | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | | |
| | А | в | –40°C to 85°C | 0.5 | 5 | 0.5 | 4 | 0.5 | 4 | 0.5 | 4 | | | |
| | Propagation | A | D | -40°C to 125°C | 0.5 | 5 | 0.5 | 4 | 0.5 | 4 | 0.5 | 4 | | |
| t _{pd} | delay B | D | • | -40°C to 85°C | 0.5 | 5 | 0.5 | 5 | 0.5 | 4 | 0.5 | 4 | ns | |
| | | Б | A | -40°C to 125°C | 0.5 | 6 | 0.5 | 5 | 0.5 | 4 | 0.5 | 4 | | |
| | | - | OE | А | –40°C to 85°C | 0.5 | 22 | 0.5 | 22 | 0.5 | 22 | 0.5 | 22 | |
| | Disable | OL | A | -40°C to 125°C | 0.5 | 24 | 0.5 | 24 | 0.5 | 24 | 0.5 | 24 | 20 | |
| t _{dis} | time | OF | В | -40°C to 85°C | 0.5 | 30 | 0.5 | 27 | 0.5 | 25 | 0.5 | 23 | ns | |
| | | OE | в | -40°C to 125°C | 0.5 | 33 | 0.5 | 30 | 0.5 | 27 | 0.5 | 25 | | |
| | | OE | А | –40°C to 85°C | 0.5 | 9 | 0.5 | 9 | 0.5 | 9 | 0.5 | 9 | | |
| | Enchla time | UE | А | -40°C to 125°C | 0.5 | 10 | 0.5 | 10 | 0.5 | 10 | 0.5 | 10 | 20 | |
| t _{en} | Enable time | OE | в | –40°C to 85°C | 0.5 | 13 | 0.5 | 10 | 0.5 | 8 | 0.5 | 7 | ns | |
| | | | UE | D | -40°C to 125°C | 0.5 | 14 | 0.5 | 11 | 0.5 | 8 | 0.5 | 7 | |

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6.14 Operating Characteristics: T_A = 25°C

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| | PARAMETER | TES | ST CONDITIONS | MIN TYP | MAX | UNIT | | | | |
|------------------|---|---|-------------------------------------|---------|------------|------|--|--|--|--|
| | | | $V_{CCA} = V_{CCB} = 0.7 V$ | 1.2 | | | | | | |
| | | | $V_{CCA} = V_{CCB} = 0.8 V$ | 1.8 | | | | | | |
| | | | $V_{CCA} = V_{CCB} = 0.9 V$ | 1.8 | | | | | | |
| ~ | Power dissipation | $C_L = 0, R_L = Open$ | $V_{CCA} = V_{CCB} = 1.2 V$ | 1.7 | | pF | | | | |
| C _{pdA} | capacitance per transceiver (A to B: outputs enabled) | $f = 1 \text{ MHz}, t_r = t_f = 1 \text{ ns}$ | $V_{CCA} = V_{CCB} = 1.5 V$ | 1.7 | 1.7 1.7 | | | | | |
| | · · · · · · · · · · · · · · · · · · · | | $V_{CCA} = V_{CCB} = 1.8 V$ | 1.7 | | | | | | |
| | | | $V_{CCA} = V_{CCB} = 2.5 V$ | 2 | | | | | | |
| | | | $V_{CCA} = V_{CCB} = 3.3 V$ | 2.5 | | | | | | |
| | | | $V_{CCA} = V_{CCB} = 0.7 V$ | 1.1 | | | | | | |
| | | | $V_{CCA} = V_{CCB} = 0.8 V$ | 1.8 | | | | | | |
| | | | $V_{CCA} = V_{CCB} = 0.9 V$ | 1.8 | | | | | | |
| ~ | Power dissipation | $C_1 = 0, R_1 = Open$ | $V_{CCA} = V_{CCB} = 1.2 V$ | 1.7 | | _ | | | | |
| C _{pdA} | capacitance per transceiver (A to B: outputs disabled) | $f = 1 \text{ MHz}, t_r = t_f = 1 \text{ ns}$ | $V_{CCA} = V_{CCB} = 1.5 V$ | 1.7 | | pF | | | | |
| | | | $V_{CCA} = V_{CCB} = 1.8 V$ | 1.7 | | | | | | |
| | | | $V_{CCA} = V_{CCB} = 2.5 V$ | 2 | | | | | | |
| | | | $V_{CCA} = V_{CCB} = 3.3 V$ | 2.1 | | | | | | |
| | | | $V_{CCA} = V_{CCB} = 0.7 V$ | 9.3 | | | | | | |
| | | $C_L = 0$, $R_L = Open$ f = 1 MHz, $t_r = t_f = 1$ ns | $V_{CCA} = V_{CCB} = 0.8 V$ | 11.8 | 3 | | | | | |
| | | | $V_{CCA} = V_{CCB} = 0.9 V$ | 11.8 | 3 | pF | | | | |
| _ | Power dissipation | | $V_{CCA} = V_{CCB} = 1.2 V$ | 12 | | | | | | |
| C _{pdA} | capacitance per transceiver (B to A: outputs enabled) | | $V_{CCA} = V_{CCB} = 1.5 V$ | 12.2 | 2 | | | | | |
| | (| | $V_{CCA} = V_{CCB} = 1.8 V$ | 13 | | | | | | |
| | | | $V_{CCA} = V_{CCB} = 2.5 V$ | 16.4 | ļ | 1 | | | | |
| | | | $V_{CCA} = V_{CCB} = 3.3 V$ | 18.1 | | | | | | |
| | | | $V_{CCA} = V_{CCB} = 0.7 V$ | 2.6 | | | | | | |
| | | | $V_{CCA} = V_{CCB} = 0.8 V$ | 1.2 | | | | | | |
| | | | $V_{CCA} = V_{CCB} = 0.9 V$ | 1.1 | | | | | | |
| | Power dissipation | $C_L = 0, R_L = Open$ | $V_{CCA} = V_{CCB} = 1.2 V$ | 1.2 | | | | | | |
| pdA | capacitance per transceiver (B to A: outputs disabled) | $f = 1 \text{ MHz}, t_r = t_f = 1 \text{ ns}$ | $V_{CCA} = V_{CCB} = 1.5 V$ | 1.2 | | pF | | | | |
| | , | | $V_{CCA} = V_{CCB} = 1.8 \text{ V}$ | 1.3 | | | | | | |
| | | | $V_{CCA} = V_{CCB} = 2.5 V$ | 1.6 | | | | | | |
| | | | $V_{CCA} = V_{CCB} = 3.3 V$ | 3.9 | | | | | | |

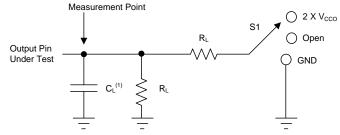
Operating Characteristics: $T_A = 25^{\circ}C$ (continued)

| | PARAMETER | TES | T CONDITIONS | MIN T | YP MAX | UNIT | | |
|------------------|---|---|-------------------------------------|-------|--------|------|--|--|
| | | | $V_{CCA} = V_{CCB} = 0.7 V$ | g | .3 | | | |
| | | | $V_{CCA} = V_{CCB} = 0.8 V$ | 1 | 1.7 | | | |
| | | | $V_{CCA} = V_{CCB} = 0.9 V$ | 1 | 1.8 | | | |
| <u> </u> | Power dissipation capacitance per transceiver | $C_L = 0, R_L = Open$ | $V_{CCA} = V_{CCB} = 1.2 V$ | 1 | 1.9 | | | |
| C _{pdB} | (A to B: outputs enabled) | $f = 1 \text{ MHz}, t_r = t_f = 1 \text{ ns}$ | $V_{CCA} = V_{CCB} = 1.5 V$ | 1: | 2.2 | pF | | |
| | | | $V_{CCA} = V_{CCB} = 1.8 V$ | 1: | 2.9 | | | |
| | | | $V_{CCA} = V_{CCB} = 2.5 V$ | 10 | 6.3 | | | |
| | | | $V_{CCA} = V_{CCB} = 3.3 V$ | 1 | 8 | | | |
| | | | $V_{CCA} = V_{CCB} = 0.7 V$ | 2 | .6 | | | |
| | | | $V_{CCA} = V_{CCB} = 0.8 V$ | 1 | 1.7 | | | |
| | | | $V_{CCA} = V_{CCB} = 0.9 V$ | 1 | 1.8 | | | |
| C | Power dissipation | $C_L = 0, R_L = Open$ | $V_{CCA} = V_{CCB} = 1.2 V$ | 1 | 1.9 | | | |
| C _{pdB} | capacitance per transceiver (A to B: outputs disabled) | $f = 1 MHz$, $t_r = t_f = 1 ns$ | $V_{CCA} = V_{CCB} = 1.5 V$ | 1: | 2.2 | pF | | |
| | | | $V_{CCA} = V_{CCB} = 1.8 V$ | 1: | 2.9 | | | |
| | | | $V_{CCA} = V_{CCB} = 2.5 V$ | 10 | 6.3 | | | |
| | | | $V_{CCA} = V_{CCB} = 3.3 V$ | 3 | .9 | | | |
| | | | $V_{CCA} = V_{CCB} = 0.7 V$ | 1 | .2 | | | |
| | | $C_L = 0$, $R_L = Open$ f = 1 MHz, $t_r = t_f = 1$ ns | $V_{CCA} = V_{CCB} = 0.8 V$ | 1 | .8 | | | |
| | | | $V_{CCA} = V_{CCB} = 0.9 V$ | 1 | .8 | pF | | |
| C | Power dissipation capacitance per transceiver | | $V_{CCA} = V_{CCB} = 1.2 V$ | 1 | .7 | | | |
| C _{pdB} | (B to A: outputs enabled) | | $V_{CCA} = V_{CCB} = 1.5 V$ | 1 | .7 | | | |
| | | | $V_{CCA} = V_{CCB} = 1.8 V$ | 1 | .7 | | | |
| | | | $V_{CCA} = V_{CCB} = 2.5 V$ | | 2 | | | |
| | | | $V_{CCA} = V_{CCB} = 3.3 V$ | | | | | |
| | | | $V_{CCA} = V_{CCB} = 0.7 V$ | 1 | .1 | | | |
| | | | $V_{CCA} = V_{CCB} = 0.8 V$ | 1 | .8 | | | |
| | | | $V_{CCA} = V_{CCB} = 0.9 V$ | 1 | .8 | | | |
| C | Power dissipation capacitance per transceiver | C _L = 0, R _L = Open | $V_{CCA} = V_{CCB} = 1.2 V$ | 1 | .7 | | | |
| C _{pdB} | (B to A: outputs disabled) | $f = 1 \text{ MHz}, t_r = t_f = 1 \text{ ns}$ | $V_{CCA} = V_{CCB} = 1.5 V$ | 1 | .7 | pF | | |
| | (| | $V_{CCA} = V_{CCB} = 1.8 \text{ V}$ | 1 | .7 | | | |
| | | | $V_{CCA} = V_{CCB} = 2.5 V$ | | 2 | | | |
| | | | $V_{CCA} = V_{CCB} = 3.3 \text{ V}$ | 2 | .1 | | | |

7 Parameter Measurement Information

Unless otherwise noted, all input pulses are supplied by generators having the following characteristics:

- f =1 MHz
- Z₀ = 50 Ω
- dv / dt ≤ 1 ns/V



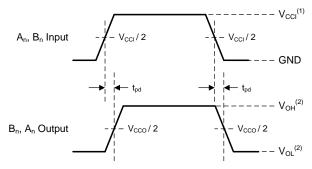
(1) C_L includes probe and jig capacitance.

| Parameter | V _{cco} | R_{L} | CL | S1 | V _{TP} |
|--------------------------------|------------------|---------|-------|---------------|-----------------|
| t _{pd} | 1.1 V - 3.6 V | 2 kΩ | 15 pF | Open | N/A |
| νþu | 0.65 V - 0.95 V | 20 kΩ | 15 pF | Open | N/A |
| | 3 V - 3.6 V | 2 kΩ | 15 pF | $2 X V_{CCO}$ | 0.3 V |
| . (1) . (1) | 1.65 V - 2.7 V | 2 kΩ | 15 pF | $2 X V_{CCO}$ | 0.15 V |
| $t_{en}^{(1)}, t_{dis}^{(1)}$ | 1.1 V - 1.6 V | 2 kΩ | 15 pF | $2 X V_{CCO}$ | 0.1 V |
| | 0.65 V - 0.95 V | 20 kΩ | 15 pF | $2 X V_{CCO}$ | 0.1 V |
| | 3 V - 3.6 V | 2 kΩ | 15 pF | GND | 0.3 V |
| $t_{en}^{(2)}, t_{dis}^{(2)}$ | 1.65V - 2.7 V | 2 kΩ | 15 pF | GND | 0.15 V |
| - us | 1.1 V - 1.6 V | 2 kΩ | 15 pF | GND | 0.1 V |
| | 0.65 V - 0.95 V | 20 kΩ | 15 pF | GND | 0.1 V |

Figure 1. Load Circuit

- (1) Output waveform on the conditions that input is driven to a valid Logic Low.
- (2) Output waveform on the condition that input is driven to a valid Logic High.

Figure 2. Load Circuit Conditions

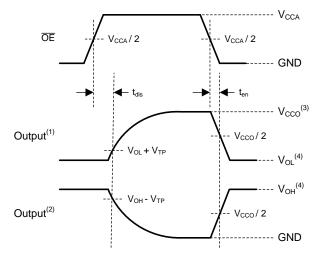


- (1) V_{CCI} is the supply pin associated with the input port.
- (2) V_{OH} and V_{OL} are typical output voltage levels with specified R_L, C_L, and S₁.

Figure 3. Propagation Delay



Parameter Measurement Information (continued)



- (1) Output waveform on the condition that input is driven to a valid Logic Low.
- (2) Output waveform on the condition that input is driven to a valid Logic High.
- (3) V_{CCO} is the supply pin associated with the output port.
- (4) V_{OH} and V_{OL} are typical output voltage levels with specified R_L, C_L, and S₁.

Figure 4. Enable Time And Disable Time

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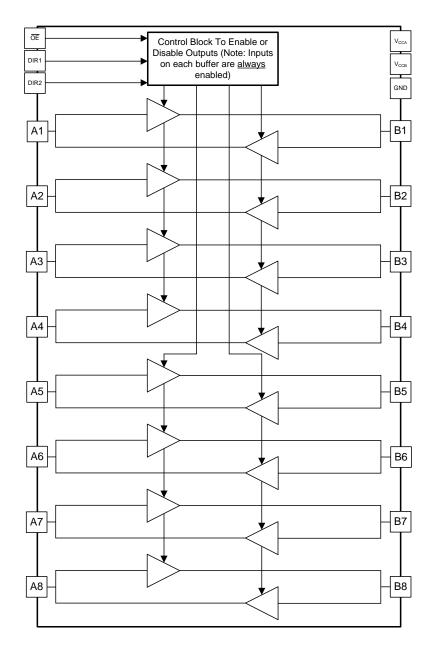
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8 Detailed Description

8.1 Overview

The SN74AXC8T245 device is an 8-bit, dual-supply non-inverting transceive<u>r</u> with bidirectional voltage level translation. The I/O pins labeled with A and the control pins (DIR1, DIR2, and \overline{OE}) are supported by V_{CCA}, and the I/O pins labeled with B are supported by V_{CCB}. Both the A port and the B port are able to accept I/O voltages ranging from 0.65 V to 3.6 V.

8.2 Functional Block Diagram





8.3 Feature Description

8.3.1 Up-Translation and Down-Translation From 0.65 V to 3.6 V

Both supply pins are configured from 0.65 V to 3.6 V, which makes the device suitable for translating between any of the low voltage nodes (0.7 V, 0.8 V, 0.9 V, 1.2 V, 1.8 V, 2.5 V, and 3.3 V).

8.3.2 Multiple Direction Control Pins

Two control pins are used to configure the 8 data I/Os. I/O channels 1 through 4 are grouped together and I/O channels 5 through 8 are banked together. The benefit of this is to permit simultaneous up-translation and down-translation within one device. This eliminates the need for multiple devices, where each device can only provide up-translation or down-translation sequentially. Simultaneous up and down translation is supported when both V_{CCA} and V_{CCB} are at least 1.40 V.

8.3.3 I_{off} Supports Partial-Power-Down Mode Operation

This feature is to limit the leakage current of an I/O pin being driven to a voltage as large as 3.6 V while having its corresponding power supply rail powered down. This is represented by the I_{off} parameter in the *Electrical Characteristics* table.

8.4 Device Functional Modes

All control inputs are referenced to V_{CCA} and must be driven to a valid Logic High or Logic Low (that is, not floating) to assure proper device operation and to prevent excessive power consumption. Table 1 summarizes the possible modes of device operation based on the configuration of the control inputs.

| | CONTROL INPUTS | | Signal Direction | | | | | |
|----|----------------|------|------------------|----------|--|--|--|--|
| OE | DIR1 | DIR2 | Bits 1:4 | Bits 5:8 | | | | |
| Н | X | Х | Disabled (Hi-Z) | | | | | |
| L | L | L | B to A | | | | | |
| L | L | Н | B to A | A to B | | | | |
| L | Н | L | A to B | | | | | |
| L | Н | Н | A to B | B to A | | | | |

Table 1. Function Table⁽¹⁾

(1) Input circuits of the data I/Os are always active and must be driven to a valid logic level.

9 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

The SN74AXC8T245 device can be used in level-translation applications for interfacing devices or systems operating at different voltage nodes. Figure 5 depicts an application in which the SN74AXC8T245 device is uptranslating a 0.7 V input to a 3.3 V output to interface between a system controller and a peripheral device.

9.2 Typical Application

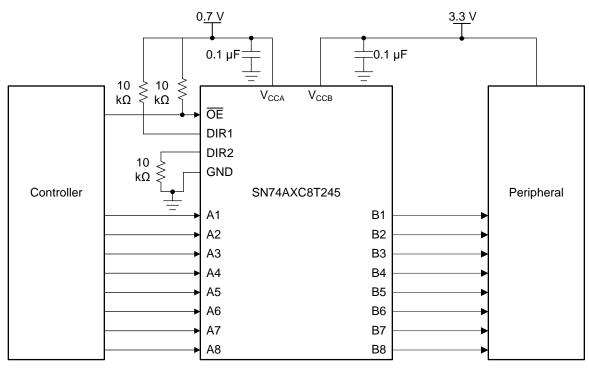


Figure 5. Typical Application Schematic



Typical Application (continued)

9.2.1 Design Requirements

For this design example, use the parameters listed in Table 2.

| Table 2. Design Falameters | | | | | | | | | |
|----------------------------|-----------------|--|--|--|--|--|--|--|--|
| DESIGN PARAMETERS | EXAMPLE VALUE | | | | | | | | |
| Input voltage range | 0.65 V to 3.6 V | | | | | | | | |
| Output voltage range | 0.65 V to 3.6 V | | | | | | | | |

Table 2. Design Parameters

9.2.2 Detailed Design Procedure

To begin the design process, determine the following:

- Input voltage range
 - Use the supply voltage of the device that is driving the SN74AXC8T245 device to determine the input voltage range. For a valid logic high the value must exceed the V_{IH} of the input port. For a valid logic low the value must be less than the V_{IL} of the input port.
- Output voltage range
 - Use the supply voltage of the device that the SN74AXC8T245 device is driving to determine the output voltage range.

9.2.3 Application Curve

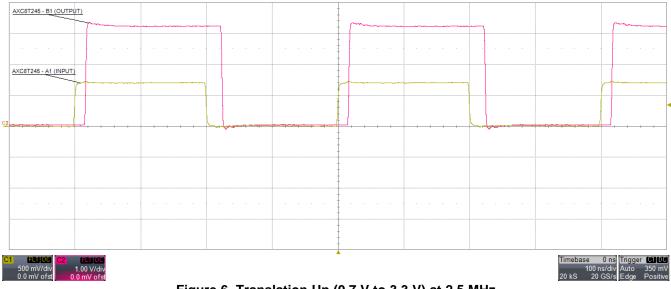


Figure 6. Translation Up (0.7 V to 3.3 V) at 2.5 MHz

10 Power Supply Recommendations

Always apply a ground reference to the GND pins first. However, there are no additional requirements for power supply sequencing.

This device was designed with various power supply sequencing methods in mind to help prevent unintended triggering of downstream devices. For more information regarding the power up glitch performance of the AXC family of level translators, see the *Power Sequencing for AXC Family of Devices* application report.

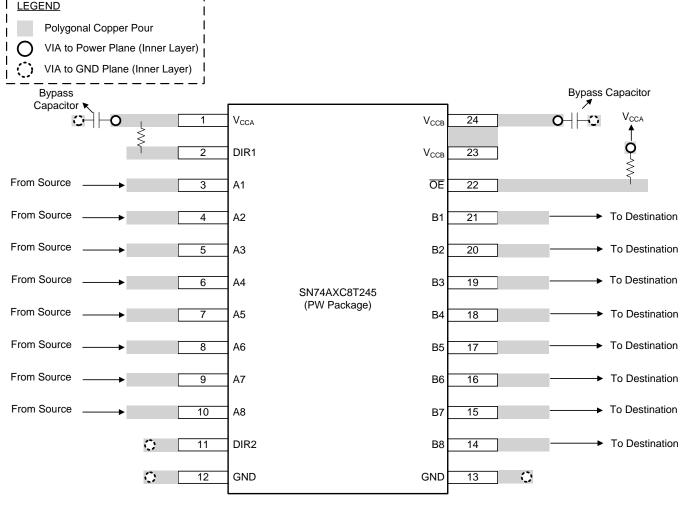
11 Layout

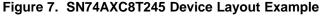
11.1 Layout Guidelines

To assure reliability of the device, follow common printed-circuit board layout guidelines.

- Use bypass capacitors on power supplies.
- Use short trace lengths to avoid excessive loading.
- Place pads on the signal paths for loading capacitors or pullup resistors to help adjust rise and fall times of signals depending on the system requirements.

11.2 Layout Example





Product Folder Links: SN74AXC8T245



12 Device and Documentation Support

12.1 Documentation Support

12.1.1 Related Documentation

For related documentation see the following:

Texas Instruments, *Implications of Slow or Floating CMOS Inputs* application report Texas Instruments, *Power Sequencing for AXC Family of Devices* application report

12.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

12.3 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E[™] Online Community *TI's Engineer-to-Engineer (E2E) Community.* Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support TI's Design Support Quickly find helpful E2E forums along with design support tools and contact information for technical support.

12.4 Trademarks

E2E is a trademark of Texas Instruments. All other trademarks are the property of their respective owners.

12.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

12.6 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



3-Jul-2018

PACKAGING INFORMATION

| Orderable Device | | Package Type | • | Pins | - | Eco Plan | Lead/Ball Finish | MSL Peak Temp | Op Temp (°C) | Device Marking | Samples |
|------------------|--------|--------------|---------|------|------|----------------------------|------------------|--------------------|--------------|----------------|---------|
| | (1) | | Drawing | | Qty | (2) | (6) | (3) | | (4/5) | |
| SN74AXC8T245PWR | ACTIVE | TSSOP | PW | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | AX8T245 | Samples |
| SN74AXC8T245RHLR | ACTIVE | VQFN | RHL | 24 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 125 | AX8T245 | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

3-Jul-2018

PACKAGE MATERIALS INFORMATION

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Texas Instruments

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal | | | | | | | | | | | | |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
| SN74AXC8T245PWR | TSSOP | PW | 24 | 2000 | 330.0 | 16.4 | 6.95 | 8.3 | 1.6 | 8.0 | 16.0 | Q1 |
| SN74AXC8T245RHLR | VQFN | RHL | 24 | 3000 | 330.0 | 12.4 | 3.8 | 5.8 | 1.2 | 8.0 | 12.0 | Q1 |

TEXAS INSTRUMENTS

www.ti.com

PACKAGE MATERIALS INFORMATION

3-Jul-2018



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74AXC8T245PWR | TSSOP | PW | 24 | 2000 | 367.0 | 367.0 | 38.0 |
| SN74AXC8T245RHLR | VQFN | RHL | 24 | 3000 | 367.0 | 367.0 | 35.0 |

PW (R-PDSO-G24)

PLASTIC SMALL OUTLINE



NOTES:

A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 B. This drawing is subject to change without notice.

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.

Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.

E. Falls within JEDEC MO-153



LAND PATTERN DATA

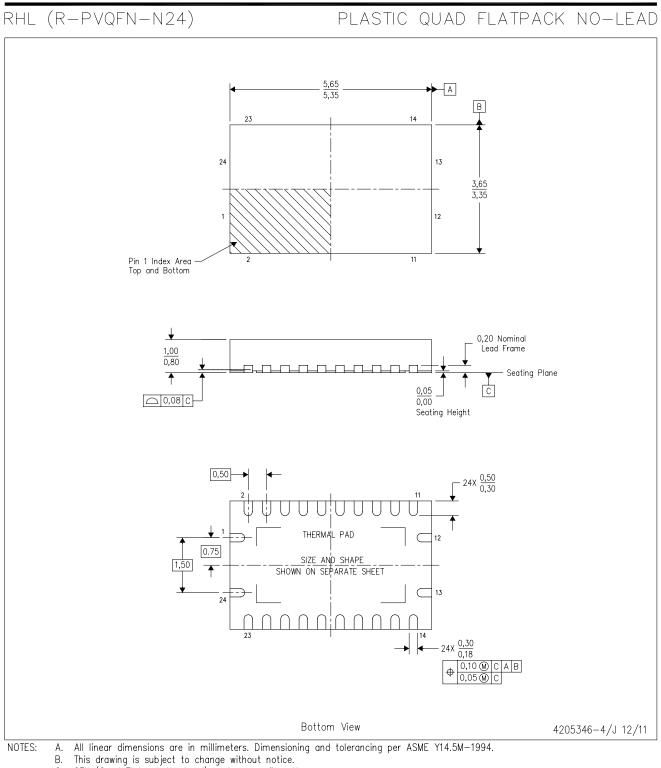


NOTES: Α. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
 C. Publication IPC-7351 is recommended for alternate design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

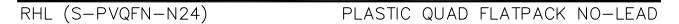


MECHANICAL DATA



- C. QFN (Quad Flatpack No-Lead) package configuration.
- D. The package thermal pad must be soldered to the board for thermal and mechanical performance.
- E. See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.
- F. JEDEC MO-241 package registration pending.



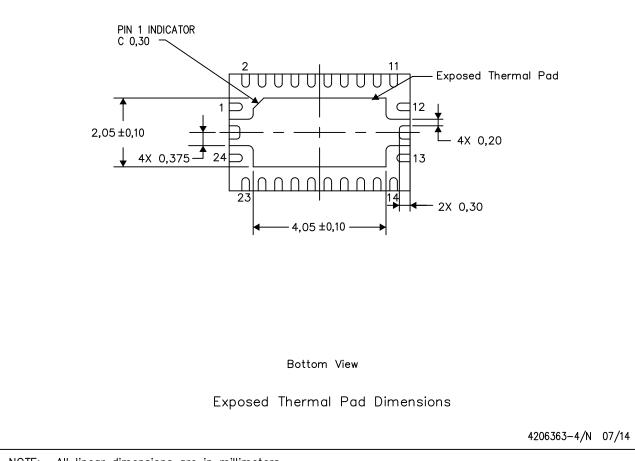


THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

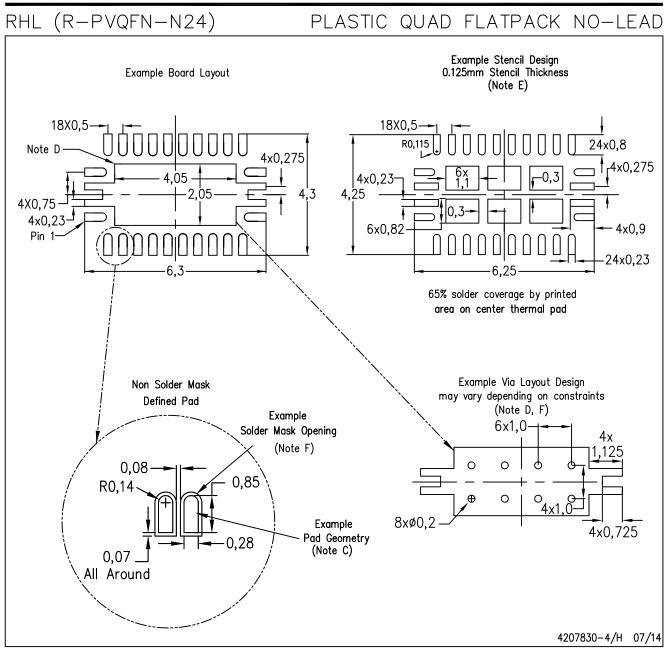
For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271. This document is available at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.



NOTE: All linear dimensions are in millimeters





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.

D. This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, Quad Flat-Pack Packages, Texas Instruments Literature No. SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com http://www.ti.com.

- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
- F. Customers should contact their board fabrication site for minimum solder mask web tolerances between signal pads.



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